

### **Product data sheet**

## 1. General description

Planar passivated SCR with sensitive gate in a SOT223 surface mountable plastic package. This SCR is designed to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

## 2. Features and benefits

- On-state RMS current, 1.25 A
- Repetitive peak off-state voltage, 1000 V
- · High surge current capability
- Direct triggering from low power drivers and logic ICs
- · Planar passivated for voltage ruggedness and reliability
- Surface mountable package

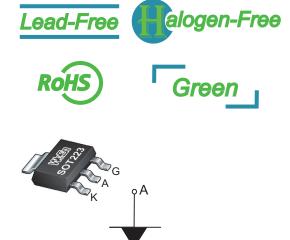
## 3. Applications

- GFCI (Ground Fault Circuit Interrupter)
- AFCI (Arc Fault Circuit Interrupter)
- RCD (Residual Current Device)
- RCBO (Residual Current circuit Breaker with Overload protection)
- AFDD (Arc Fault Detection Device)

## 4. Quick reference data

### Table 1. Quick reference data

| Symbol                              | Values | Unit |
|-------------------------------------|--------|------|
| V <sub>drm</sub> , V <sub>rrm</sub> | 1000   | V    |
| I <sub>T(RMS)</sub>                 | 1.25   | А    |
| I <sub>GT</sub>                     | ≤90    | μΑ   |
| Tj                                  | 125    | °C   |



 $V_{\text{DRM}}$ 

|  | voltage                          |   |            |                  |
|--|----------------------------------|---|------------|------------------|
| $V_{\text{RRM}}$                         | repetitive peak reverse voltage  |   | 1000       | V                |
| $I_{\mathrm{T}(\mathrm{AV})}$            | average on-state current         | half sine wave; T <sub>c</sub> ≤ 105 °C               | 0.8        | Α                |
| $\mathbf{I}_{\mathrm{T}(\mathrm{RMS})}$  | RMS on-state current             | half sine wave; T <sub>c</sub> ≤ 105 °C               | 1.25       | Α                |
| I <sub>TSM</sub> non-repetitive peak on- |                                  | half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms  | 23         | А                |
| state current                            |                                  | half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms | 25         | А                |
| l <sup>2</sup> t                         | I <sup>2</sup> t for fusing      | t <sub>p</sub> = 10 ms; sine-wave pulse               | 2.645      | A <sup>2</sup> s |
| dl <sub>⊤</sub> /dt                      | rate of rise of on-state current | I <sub>G</sub> = 0.1 mA                               | 100        | A/µs             |
| I <sub>GM</sub>                          | peak gate current                |   | 1.2        | Α                |
| $P_{GM}$                                 | peak gate power                  |   | 2          | W                |
| $P_{G(AV)}$                              | average gate power               | over any 20 ms period                                 | 0.2        | W                |
| T <sub>stg</sub>                         | storage temperature              |   | -40 to 150 | °C               |
| Tj                                       | junction temperature             |   | -40 to 125 | °C               |

### **Table 3. Electrical Characteristics**

| Symbol              | Parameter                         | Conditions  |                         |  | Min  | Тур | Max  | Unit |
|---------------------|-----------------------------------|---|-------------------------|--|------|-----|------|------|
| Static ch           | naracteristics                    |   |                         |  |      |     |      |      |
| I <sub>GT</sub>     | gate trigger current              | $V_{D}$ = 12 V; $R_{L}$ = 100 $\Omega$ ; $T_{j}$ = 25   | °C                      |  | 10   | -   | 90   | μA   |
| $V_{\rm GT}$        | gate trigger voltage              | V <sub>D</sub> = 12 V; R <sub>L</sub> = 100 Ω; T <sub>j</sub> = 25 °C   |                         |  | -    | 0.6 | 0.8  | V    |
|                     |                                   | V <sub>D</sub> = 800 V; I <sub>T</sub> = 0.1 A;T <sub>j</sub> = 125 °C  |                         |  | 0.25 | 0.4 | -    | V    |
| $V_{RG}$            | gate reverse voltage              | I <sub>RG</sub> = 2 mA  |                         |  | 10   | -   | -    | V    |
| IL                  | latching current                  | I <sub>T</sub> = 0.1 A; R <sub>GK</sub> = 1 kΩ; T <sub>j</sub> = 25 °C  |                         |  | -    | -   | 5    | mA   |
| I <sub>H</sub>      | holding current                   | $V_{\rm D}$ = 12 V; $R_{\rm GK}$ = 1 kΩ; $T_{\rm j}$ = 25 °C  |                         |  | -    | -   | 3    | mA   |
| V <sub>T</sub>      | on-state voltage                  | I <sub>T</sub> = 2.5 A; T <sub>j</sub> = 25 °C  |                         |  | -    | -   | 1.45 | V    |
| I <sub>DRM</sub>    | off-state current                 |   | T <sub>j</sub> = 25 °C  |  | -    | -   | 1    | μA   |
| I <sub>RRM</sub>    | reverse current                   | $V_{\rm D} = V_{\rm DRM} / V_{\rm RRM}; R_{\rm GK} = 1 \text{ k}\Omega$   | T <sub>j</sub> = 125 °C |  | -    | -   | 100  | μA   |
| Dynamic             | Dynamic characteristics           |   |                         |  |      |     |      |      |
| dV <sub>D</sub> /dt | rate of rise of off-state voltage | $V_{DM}$ = 670 V; T <sub>j</sub> = 125 °C; R <sub>GK</sub> = 1 kΩ;<br>( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform |                         |  | 50   | -   | -    | V/µs |

5. Characteristics

repetitive peak off-state

In accordance with the Absolute Maximum Rating System (IEC 60134).

Conditions

Table 2. Limiting values

Symbol Parameter

Unit

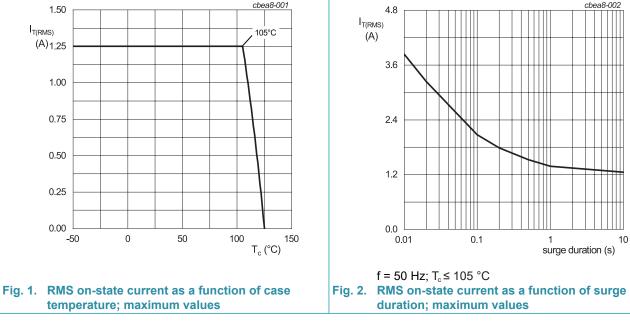
V

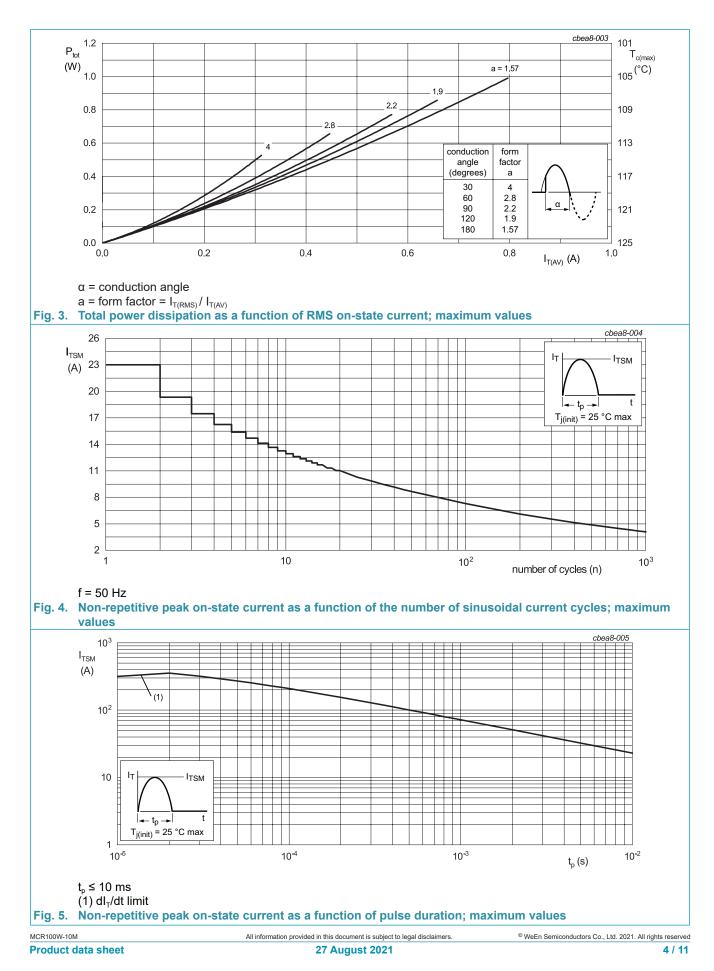
Values

1000

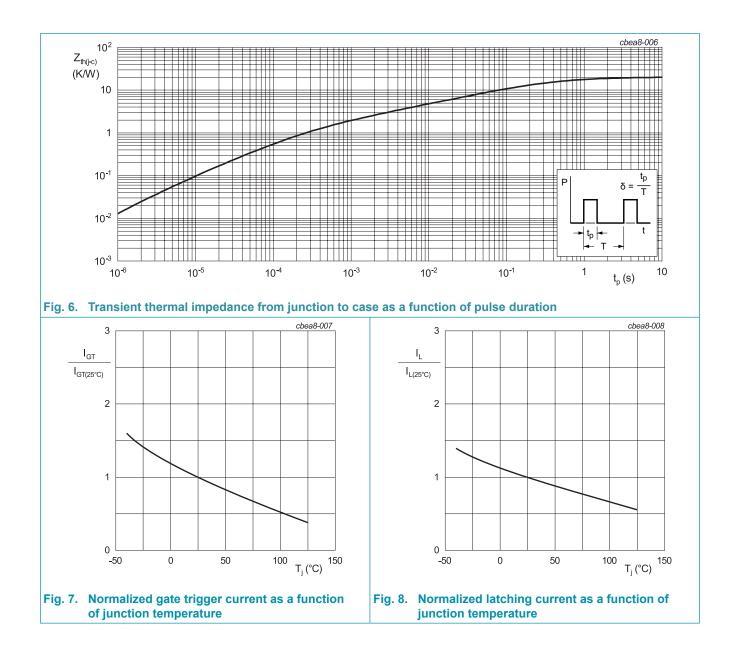
| Symbol               | Parameter   | Conditions  |        | Min | Тур | Max      | Unit |
|----------------------|---|-------------|--------|-----|-----|----------|------|
| R <sub>th(j-c)</sub> | thermal resistance<br>from junction to case       |             | SOT223 | -   | -   | 20       | K/W  |
| $R_{th(j-a)}$        | thermal resistance<br>from junction to<br>ambient | in free air | SOT223 | -   | 120 | -        | K/W  |
|                      |   |             |        |     |     |          |      |
|                      |   | chea8-001   |        |     |     | choo8_0( | 12   |

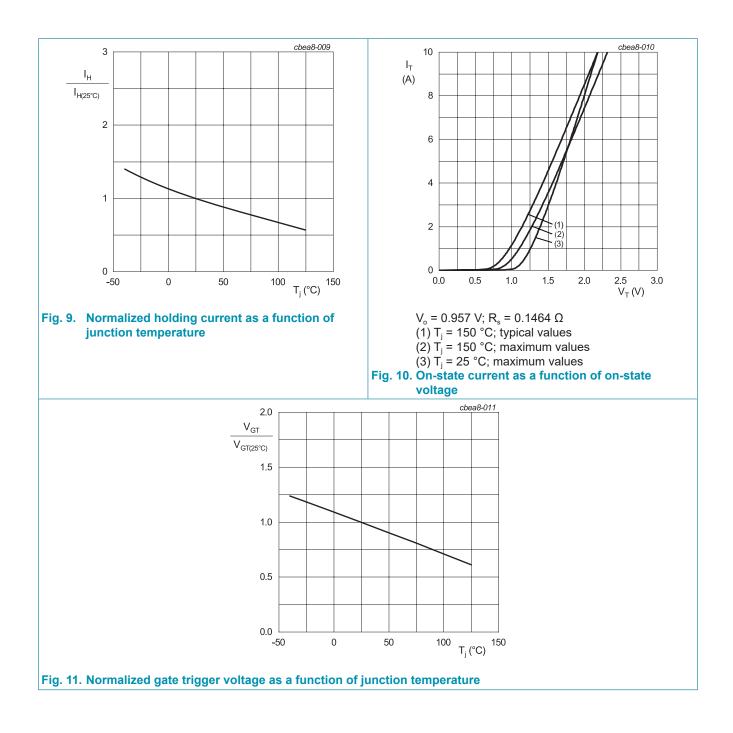
### Table 4. Thermal characteristics





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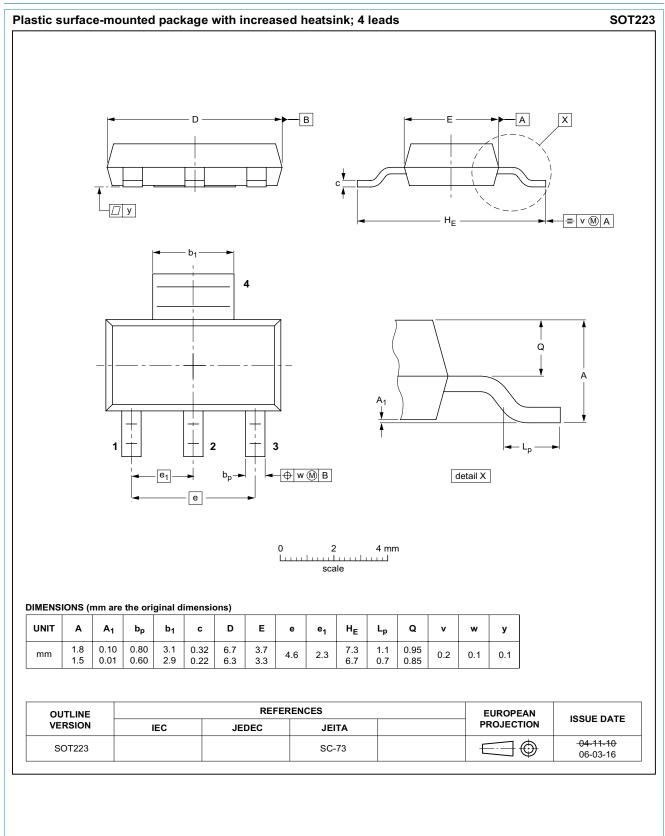
# 6. Ordering information

| Table 5. Ordering information |                 |                       |                |                           |                 |                       |  |
|-------------------------------|-----------------|-----------------------|----------------|---------------------------|-----------------|-----------------------|--|
| Type number                   | Package<br>Name | Orderable part number | Packing method | Small packing<br>quantity | Package version | Package<br>issue date |  |
| MCR100W-10M                   | SOT223          |                       | Reel           | 1000                      | SOT223          | 16-Mar-2006           |  |

# 7. Marking

| Table 6. Marking codes |               |
|------------------------|---------------|
| Type number            | Marking codes |
| MCR100W-10M            | 10M<br>MCR100 |

# 8. Package outline



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## 9. Legal information

#### Data sheet status

| Document status [1][2]               | Product<br>status [3] | Definition  |
|--------------------------------------|-----------------------|---|
| Objective<br>[short] data<br>sheet   | Development           | This document contains data from<br>the objective specification for product<br>development. |
| Preliminary<br>[short] data<br>sheet | Qualification         | This document contains data from the preliminary specification.                             |
| Product<br>[short] data<br>sheet     | Production            | This document contains the product specification.   |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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